

Electronic Acknowledgement Receipt

EFS ID:	2742044
Application Number:	10681747
International Application Number:	
Confirmation Number:	8137
Title of Invention:	SEMICONDUCTOR MULTI-PACKAGE MODULE HAVING INVERTED SECOND PACKAGE STACKED OVER DIE-UP FLIP-CHIP BALL GRID ARRAY (BGA) PACKAGE
First Named Inventor/Applicant Name:	Marcos Karnezos
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Filer:	Mikio Ishimaru/Victoria Rocha
Filer Authorized By:	Mikio Ishimaru
Attorney Docket Number:	CPAC 1029-6
Receipt Date:	18-JAN-2008
Filing Date:	08-OCT-2003
Time Stamp:	21:35:01
Application Type:	Utility under 35 USC 111(a)

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Miscellaneous Incoming Letter	27-409-5CP_Transmittal_Change_POA_Address.pdf	49010 836cd8261076083d9f2bca4d7f5e6e d57171b4	no	1

Warnings:

Information:

2	Power of Attorney	27-409-5CP_ChipPAC_Inc_ signed_POA.pdf	69127 <small>024c95bca54c05d6b6b60b9eecc6410b c01a6e06</small>	no	1
Warnings:					
Information:					
3	Assignee showing of ownership per 37 CFR 3.73(b).	27-409-5CP_STATEMENT_ under_3-73b.pdf	140763 <small>510b40091805c5d365a613b6e3d20d36 d8ac2</small>	no	2
Warnings:					
Information:					
4	Change of Address	27-409-5CP_Fee_Address_I ndication_Form.pdf	142008 <small>1427c70547167050a3b03719147621aa07 37d9991a</small>	no	2
Warnings:					
Information:					
Total Files Size (in bytes):			400908		
<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p> <p><u>New International Application Filed with the USPTO as a Receiving Office</u> If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.</p>					